



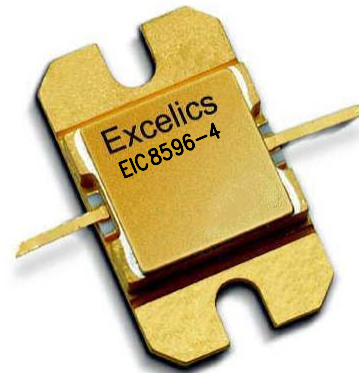
EIC8596-4

UPDATED 08/21/2007

8.50-9.60GHz 4-Watt Internally-Matched Power FET

FEATURES

- 8.50 –9.60GHz Bandwidth
- Input/Output Impedance Matched to 50 Ohms
- +36.5 dBm Output Power at 1dB Compression
- 7.5 dB Power Gain at 1dB Compression
- 30% Power Added Efficiency
- -43 dBc IM3 at $P_o = 25.5$ dBm SCL
- 100% Tested for DC, RF, and R_{TH}



ELECTRICAL CHARACTERISTICS ($T_a = 25^\circ\text{C}$)



Caution! ESD sensitive device.

SYMBOL	PARAMETERS/TEST CONDITIONS ¹	MIN	TYP	MAX	UNITS
P_{1dB}	Output Power at 1dB Compression $f = 8.50\text{-}9.60\text{GHz}$ $V_{DS} = 10\text{ V}$, $I_{DSQ} \approx 1100\text{mA}$	35.5	36.5		dBm
G_{1dB}	Gain at 1dB Compression $f = 8.50\text{-}9.60\text{GHz}$ $V_{DS} = 10\text{ V}$, $I_{DSQ} \approx 1100\text{mA}$	6.5	7.5		dB
ΔG	Gain Flatness $f = 8.50\text{-}9.60\text{GHz}$ $V_{DS} = 10\text{ V}$, $I_{DSQ} \approx 1100\text{mA}$			± 0.6	dB
PAE	Power Added Efficiency at 1dB Compression $V_{DS} = 10\text{ V}$, $I_{DSQ} \approx 1100\text{mA}$ $f = 8.50\text{-}9.60\text{GHz}$		30		%
I_{d1dB}	Drain Current at 1dB Compression $f = 8.50\text{-}9.60\text{GHz}$		1100	1300	mA
IM3	Output 3rd Order Intermodulation Distortion $\Delta f = 10\text{ MHz}$ 2-Tone Test; $P_{out} = 25.5\text{ dBm}$ S.C.L. ² $V_{DS} = 10\text{ V}$, $I_{DSQ} \approx 65\%$ IDSS $f = 9.60\text{GHz}$	-40	-43		dBc
I_{DSS}	Saturated Drain Current $V_{DS} = 3\text{ V}$, $V_{GS} = 0\text{ V}$		1800	2200	mA
V_P	Pinch-off Voltage $V_{DS} = 3\text{ V}$, $I_{DS} = 20\text{ mA}$		-2.5	-4.0	V
R_{TH}	Thermal Resistance ³		5.0	6.0	$^\circ\text{C/W}$

Note: 1. Tested with 100 Ohm gate resistor.

2. S.C.L. = Single Carrier Level.

3. Overall R_{th} depends on case mounting.

ABSOLUTE MAXIMUM RATING FOR EFE

SYMBOLS	PARAMETERS	ABSOLUTE ¹	CONTINUOUS ²
V_{ds}	Drain-Source Voltage	15V	10V
V_{gs}	Gate-Source Voltage	-5V	-4V
I_{gf}	Forward Gate Current	48mA	14.4mA
I_{gr}	Reverse Gate Current	-9.6mA	-2.4mA
P_{in}	Input Power	36.0dBm	@ 3dB Compression
T_{ch}	Channel Temperature	175C	175C
T_{stg}	Storage Temperature	-65C to +175C	-65C to +175C
P_t	Total Power Dissipation	25W	25W

Note: 1. Exceeding any of the above ratings may result in permanent damage.

2. Exceeding any of the above ratings may reduce MTTF below design goals.

Specifications are subject to change without notice.

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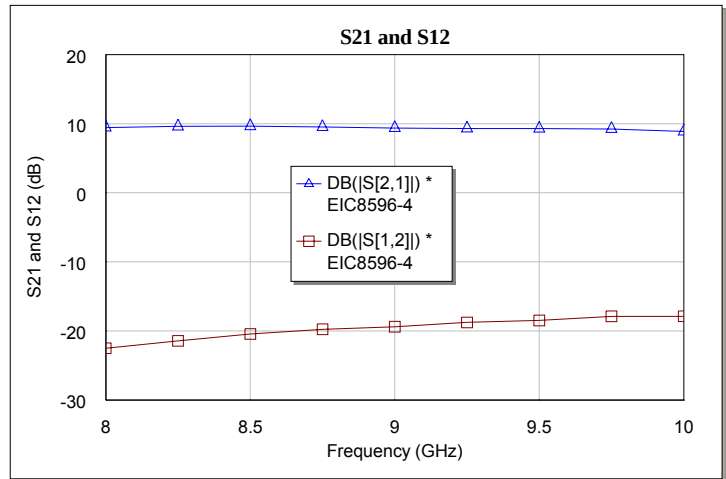
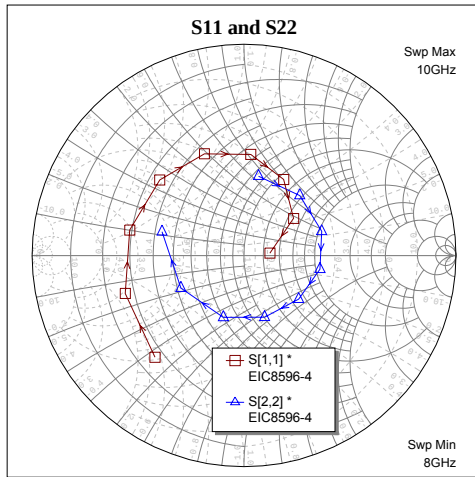
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PERFORMANCE DATA

Typical S-Parameters (T= 25°C, 50Ω system, de-embedded to edge of package)

$V_{DS} = 10\text{ V}$, $I_{DSQ} \approx 1100\text{mA}$



FREQ (GHz)	--- S11 ---		--- S21 ---		--- S12 ---		--- S22 ---	
	MAG	ANG	MAG	ANG	MAG	ANG	MAG	ANG
8.00	0.639	-131.090	2.971	-43.850	0.075	-95.770	0.381	79.650
8.25	0.589	-162.210	3.029	-71.870	0.085	-125.560	0.387	47.150
8.50	0.553	167.390	3.042	-98.890	0.095	-152.800	0.384	17.300
8.75	0.535	138.050	2.997	-125.900	0.103	-179.370	0.364	-10.280
9.00	0.516	111.210	2.947	-152.010	0.107	155.110	0.331	-38.730
9.25	0.479	86.150	2.924	-178.400	0.115	128.390	0.308	-71.620
9.50	0.406	62.550	2.918	154.530	0.119	102.590	0.309	-108.380
9.75	0.292	36.850	2.901	125.240	0.127	74.230	0.336	-152.650
10.00	0.123	5.160	2.779	94.570	0.128	44.690	0.403	163.780
10.25	0.085	-167.640	2.588	62.670	0.123	13.470	0.499	126.800
10.50	0.278	157.010	2.245	31.830	0.112	-17.580	0.564	94.870

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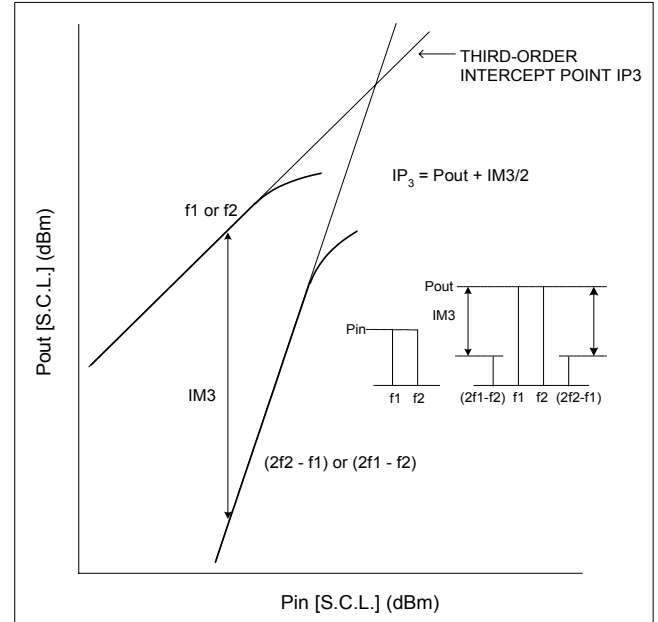
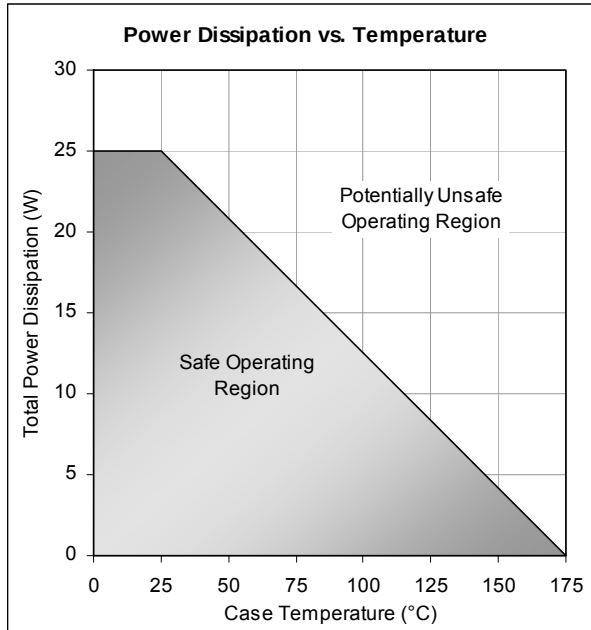


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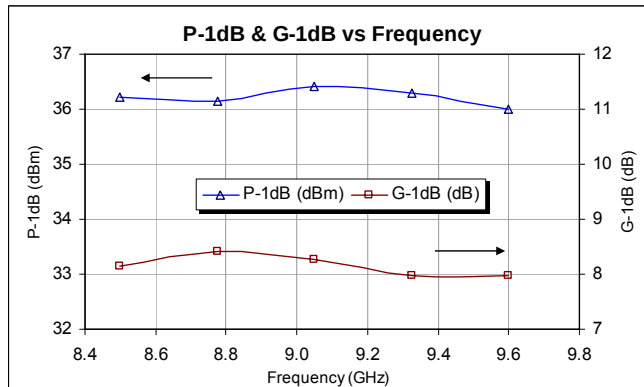
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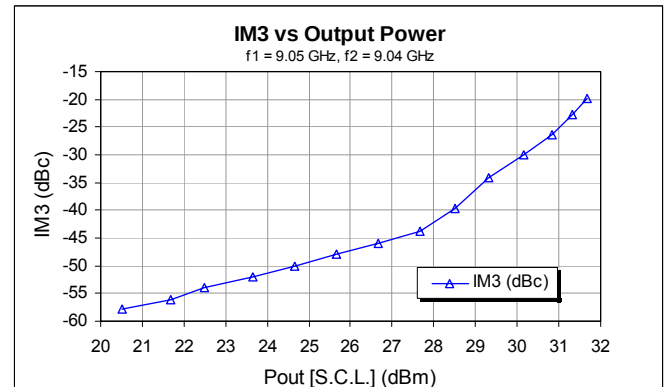
Power De-rating Curve and IM3 Definition



Typical Power Data ($V_{DS} = 10\text{ V}$, $I_{DSQ} = 1100\text{ mA}$)



Typical IM3 Data ($V_{DS} = 10\text{ V}$, $I_{DSQ} \approx 65\% I_{DSS}$)



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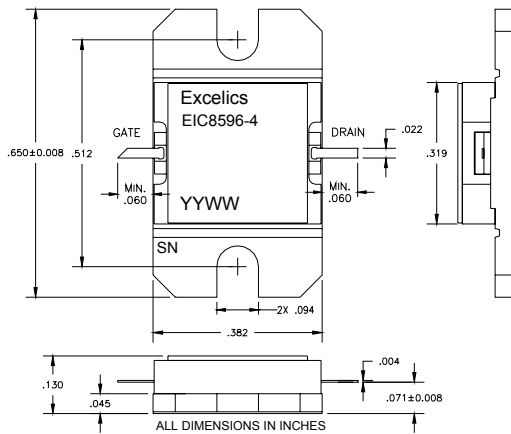
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PACKAGES OUTLINE

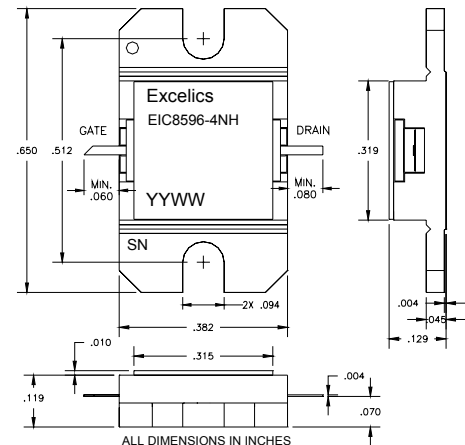
Dimensions in inches, Tolerance $\pm .005$ unless otherwise specified

EIC8596-4 (Hermetic)



Caution! ESD sensitive device.

EIC8596-4NH (Non-Hermetic)



Caution! ESD sensitive device.

ORDERING INFORMATION

Part Number	Packages	Grade ¹	f _{Test} (GHz)	P _{1dB} (min)	IM ₃ (min) ²
EIC8596-4	Hermetic	Industrial	8.50-9.60GHz	35.5	-40
EIC8596-4NH	Non-Hermetic	Industrial	8.50-9.60GHz	35.5	-40

Notes: 1. Contact factory for military and hi-rel grades.
2. Exact test conditions are specified in "Electrical Characteristics" table.

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness

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